APPLICATION DATA SHEET

Electronic Version v14

Stylesheet Version v14.0

Title of Invention

METHOD FOR SELECTIVE ELECTROPLATING OF SEMICONDUCTOR DEVICE I/O PADS USING A TITANIUM-TUNGSTEN SEED LAYER

Application Type: regular, utility

Attorney Docket Number: FIS920030278US1

Correspondence address:

Customer Number: 29371

Inventors Information:

Inventor 1:

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